

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
BEFORE THE BOARD OF PATENT APPEALS AND INTERFERENCES**

In re Application of:
H. KOMATSU, et al.

: Group Art Unit: 1795

Serial No. 10/594,548

: Examiner: John S. Y. Chu

Filed: SEPTEMBER 27, 2006

: Confirm. No: 3540

For: HEAT-RESISTANT PHOTSENSITIVE RESIN COMPOSITION, METHOD FOR
FORMING PATTERN USING THE COMPOSITION, AND ELECTRONIC PART

**NOTICE OF APPEAL FROM THE PRIMARY EXAMINER
TO THE BOARD OF APPEALS**

Mail Stop: APPEALS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

October 22, 2009

Sir:

In accordance with the provisions of 37 CFR 41.31, Applicants hereby appeal the rejection of claims 1-12, as set forth in the Office Action mailed May 22, 2009, as supplemented by the Office Action dated October 16, 2009.

The requisite fee of \$540 is submitted herewith. Also enclosed is a Petition for a two-month extension of time, along with the requisite fee (\$490.00).

Respectfully Submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

By /William I. Solomon/

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